



**Vorläufig
Preliminary**

Elektrische Eigenschaften / Electrical properties

Höchstzulässige Werte / Maximum rated values

Diode Gleichrichter/ Diode Rectifier

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	800	V
Durchlaßstrom Grenzeffektivwert pro Chip RMS forward current per chip	$T_C = 80^{\circ}\text{C}$	I_{FRMSM}	58	A
Gleichrichter Ausgang Grenzeffektivstrom maximum RMS current at Rectifier output	$T_C = 80^{\circ}\text{C}$	I_{RMSmax}	96	A
Stoßstrom Grenzwert surge forward current	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$	I_{FSM}	448	A
	$t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$		358	A
Grenzlastintegral i^2t - value	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$	I^2t	1000	A^2s
	$t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$		642	A^2s

Transistor Wechselrichter/ Transistor Inverter

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 65^{\circ}\text{C}$	$I_{C,nom.}$	20	A
	$T_C = 25^{\circ}\text{C}$	I_C	25	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 65^{\circ}\text{C}$	I_{CRM}	40	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^{\circ}\text{C}$	P_{tot}	80	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/- 20V	V

Diode Wechselrichter/ Diode Inverter

Dauergleichstrom DC forward current		I_F	20	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	I_{FRM}	40	A
Grenzlastintegral i^2t - value	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^{\circ}\text{C}$	I^2t	62	A^2s

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Technische Information / Technical Information

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IGBT-Module
IGBT-Modules

FB20R06KL4



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Modul Isolation/ Module Isolation

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	V _{ISOL}	2,5	kV
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Elektrische Eigenschaften / Electrical properties

Charakteristische Werte / Characteristic values

Diode Gleichrichter/ Diode Rectifier		min. typ. max.				
Durchlaßspannung forward voltage	T _{vj} = 150°C, I _F = 20 A	V _F	-	0,85	-	V
Schleusenspannung threshold voltage	T _{vj} = 150°C	V _(TO)	-	0,63	-	V
Ersatzwiderstand slope resistance	T _{vj} = 150°C	r _T	-	10	-	mΩ
Sperrstrom reverse current	T _{vj} = 150°C, V _R = 800 V	I _R	-	5	-	mA
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T _C = 25°C	R _{AA+CC}	-	4	-	mΩ
Transistor Wechselrichter/ Transistor Inverter		min. typ. max.				
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V _{GE} = 15V, T _{vj} = 25°C, I _C = 20 A	V _{CE sat}	-	1,95	2,55	V
	V _{GE} = 15V, T _{vj} = 125°C, I _C = 20 A		-	2,2	-	V
Gate-Schwellenspannung gate threshold voltage	V _{CE} = V _{GE} , T _{vj} = 25°C, I _C = 0,5mA	V _{GE(TO)}	4,5	5,5	6,5	V
Eingangskapazität input capacitance	f = 1MHz, T _{vj} = 25°C V _{CE} = 25 V, V _{GE} = 0 V	C _{ies}	-	1,1	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V _{GE} = 0V, T _{vj} = 125°C, V _{CE} = 600V	I _{CES}	-	5,0	-	mA
Gate-Emitter Reststrom gate-emitter leakage current	V _{CE} = 0V, V _{GE} = 20V, T _{vj} = 25°C	I _{GES}	-	-	400	nA
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	I _C = I _{Nenn} , V _{CC} = 300 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 47 Ohm	t _{d,on}	-	22	-	ns
	V _{GE} = ±15V, T _{vj} = 125°C, R _G = 47 Ohm			31		
Anstiegszeit (induktive Last) rise time (inductive load)	I _C = I _{Nenn} , V _{CC} = 300 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 47 Ohm	t _r	-	23	-	ns
	V _{GE} = ±15V, T _{vj} = 125°C, R _G = 47 Ohm			37		
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	I _C = I _{Nenn} , V _{CC} = 300 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 47 Ohm	t _{d,off}	-	143	-	ns
	V _{GE} = ±15V, T _{vj} = 125°C, R _G = 47 Ohm			154		
Fallzeit (induktive Last) fall time (inductive load)	I _C = I _{Nenn} , V _{CC} = 300 V V _{GE} = ±15V, T _{vj} = 25°C, R _G = 47 Ohm	t _f	-	22	-	ns
	V _{GE} = ±15V, T _{vj} = 125°C, R _G = 47 Ohm			38		
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I _C = I _{Nenn} , V _{CC} = 300 V V _{GE} = ±15V, T _{vj} = 125°C, R _G = 47 Ohm L _S = 80 nH	E _{on}	-	0,73	-	mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I _C = I _{Nenn} , V _{CC} = 300 V V _{GE} = ±15V, T _{vj} = 125°C, R _G = 47 Ohm L _S = 80 nH	E _{off}	-	0,56	-	mWs
Kurzschlußverhalten SC Data	t _p ≤ 10μs, V _{GE} ≤ 15V, R _G = 47 Ohm T _{vj} ≤ 125°C, V _{CC} = 360 V	I _{SC}	-	80	-	A



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Elektrische Eigenschaften / Electrical properties

Charakteristische Werte / Characteristic values

		min. typ. max.				
Modulinduktivität stray inductance module		$L_{\sigma CE}$	-	-	40	nH
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^\circ C$	R_{CC+EE}	-	13	-	m Ω

		min. typ. max.				
Diode Wechselrichter/ Diode Inverter						
Durchlaßspannung forward voltage	$V_{GE} = 0V, T_{vj} = 25^\circ C, I_F = 20 A$ $V_{GE} = 0V, T_{vj} = 125^\circ C, I_F = 20 A$	V_F	-	1,7	2,15	V
Rückstromspitze peak reverse recovery current	$I_F = I_{Nenn}, - di_F/dt = 1000 A/us$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	I_{RM}	-	20	-	A
Sperrverzögerungsladung recovered charge	$I_F = I_{Nenn}, - di_F/dt = 1000 A/us$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	Q_r	-	1	-	μAs
Abschaltenergie pro Puls reverse recovery energy	$I_F = I_{Nenn}, - di_F/dt = 1000 A/us$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	E_{rec}	-	0,2	-	mWs
			-	0,35	-	mWs

		min. typ. max.				
NTC-Widerstand/ NTC-Thermistor						
Nennwiderstand	$T_C = 25^\circ C$	R_{25}	-	5	-	k Ω
Abweichung von R_{100} deviation of R_{100}	$T_C = 100^\circ C, R_{100} = 493 \Omega$	$\Delta R/R$	-5		5	%
Verlustleistung power dissipation	$T_C = 25^\circ C$	P_{25}			20	mW
B-Wert B-value	$R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$	$B_{25/50}$		3375		K

Technische Information / Technical Information

IGBT-Module
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Thermische Eigenschaften / Thermal properties

				min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to heatsink	Gleicher. Diode/ Rectif. Diode $\lambda_{\text{paste}}=1\text{W/m}^2\text{K}$	R_{thJH}	-	1,1	-	K/W	
	Trans. Wechr./ Trans. Inverter $\lambda_{\text{grease}}=1\text{W/m}^2\text{K}$		-	1,8	-	K/W	
	Diode Wechr./ Diode Inverter		-	3,7	-	K/W	
Innerer Wärmewiderstand thermal resistance, junction to case	Gleicher. Diode/ Rectif. Diode	R_{thJC}	-	-	1	K/W	
	Trans. Wechr./ Trans. Inverter		-	-	1,6	K/W	
	Diode Wechr./ Diode Inverter		-	-	2,7	K/W	
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleicher. Diode/ Rectif. Diode $\lambda_{\text{paste}}=1\text{W/m}^2\text{K}$	R_{thCH}	-	0,2	-	K/W	
	Trans. Wechr./ Trans. Inverter $\lambda_{\text{grease}}=1\text{W/m}^2\text{K}$		-	0,4	-	K/W	
	Diode Wechr./ Diode Inverter		-	1,3	-	K/W	
Höchstzulässige Sperrschichttemperatur maximum junction temperature		T_{vj}	-	-	150	°C	
Betriebstemperatur operation temperature		T_{op}	-40	-	125	°C	
Lagertemperatur storage temperature		T_{stg}	-40	-	125	°C	

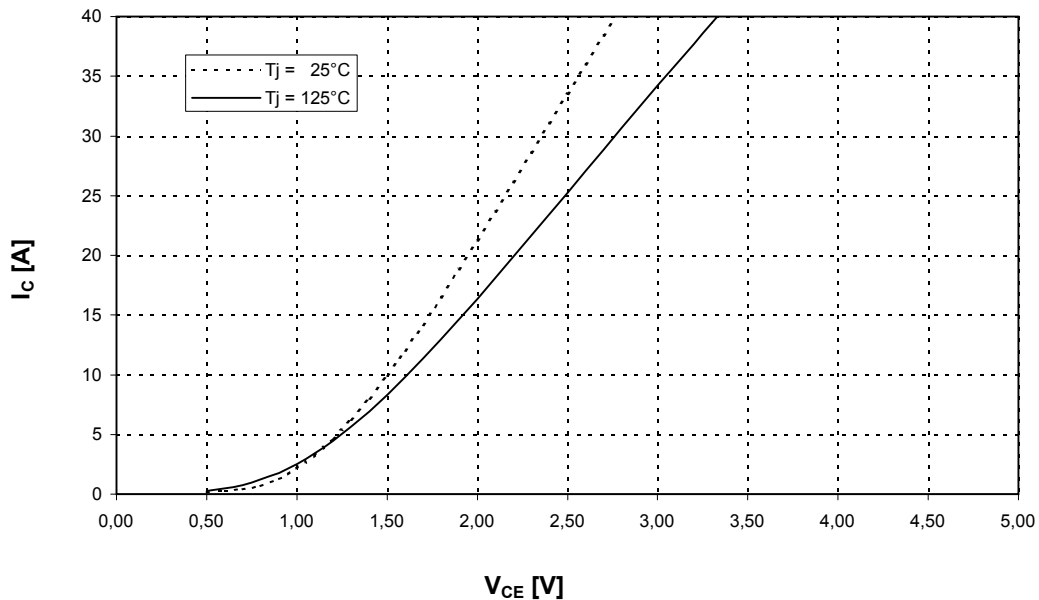
Mechanische Eigenschaften / Mechanical properties

Innere Isolation internal insulation				Al_2O_3	
CTI comperative tracking index				225	
Anpreßkraft f. mech. Befestigung pro Feder mounting force per clamp		F		40...80	N
Gewicht weight		G		36	g
Kontakt - Kühlkörper terminal to heatsink	Kriechstrecke creeping distance			13,5	mm
	Luftstrecke clearance			12	mm
Terminal - Terminal terminal to terminal	Kriechstrecke creeping distance			7,5	mm
	Luftstrecke clearance			7,5	mm

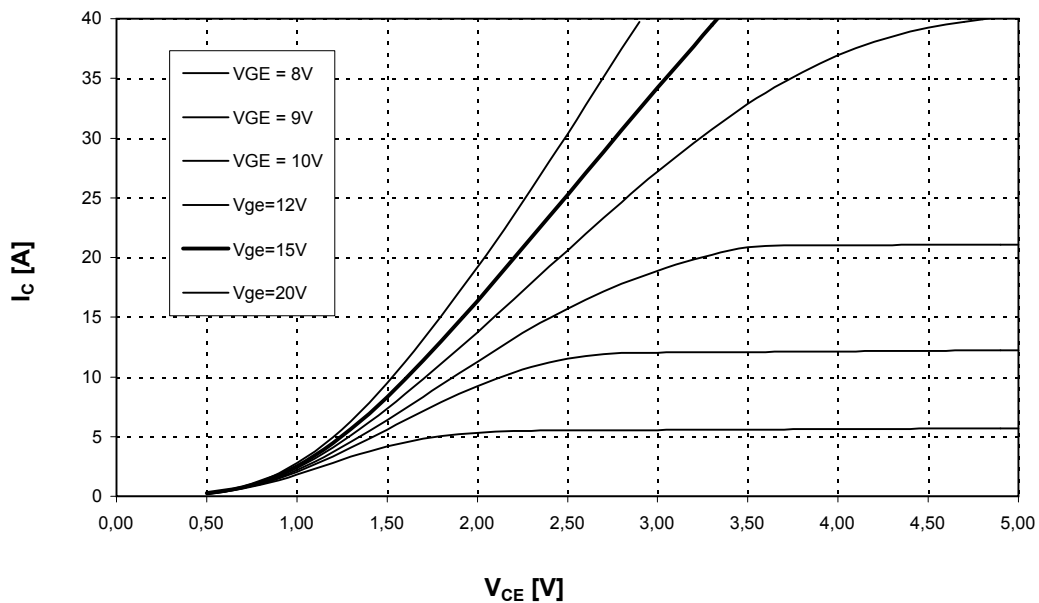


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Ausgangskennlinienfeld Wechselr. (typisch) $I_C = f(V_{CE})$
Output characteristic Inverter (typical) $V_{GE} = 15\text{ V}$



Ausgangskennlinienfeld Wechselr. (typisch) $I_C = f(V_{CE})$
Output characteristic Inverter (typical) $T_{vj} = 125^\circ\text{C}$

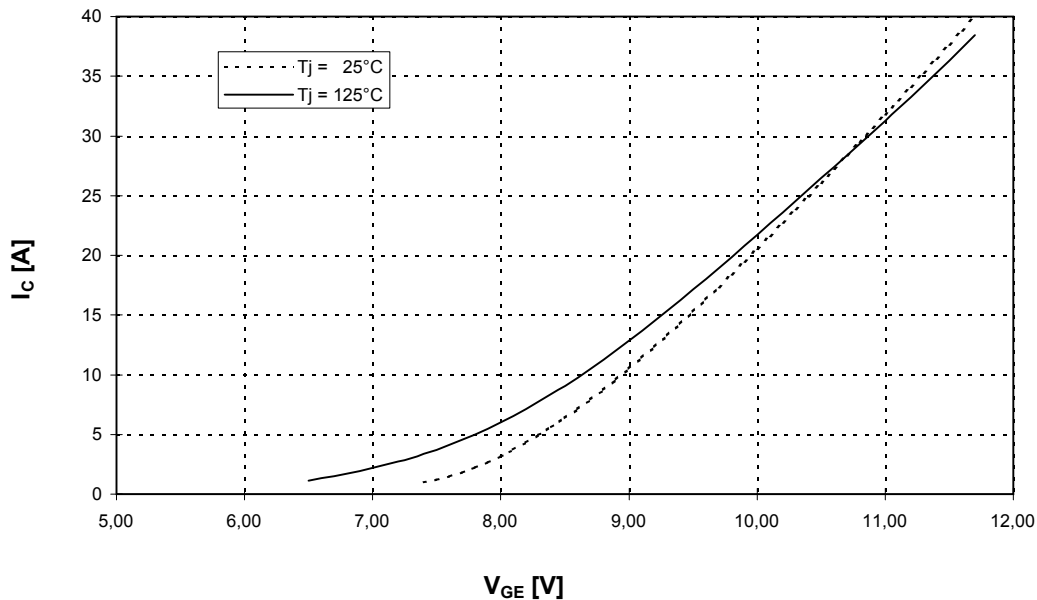




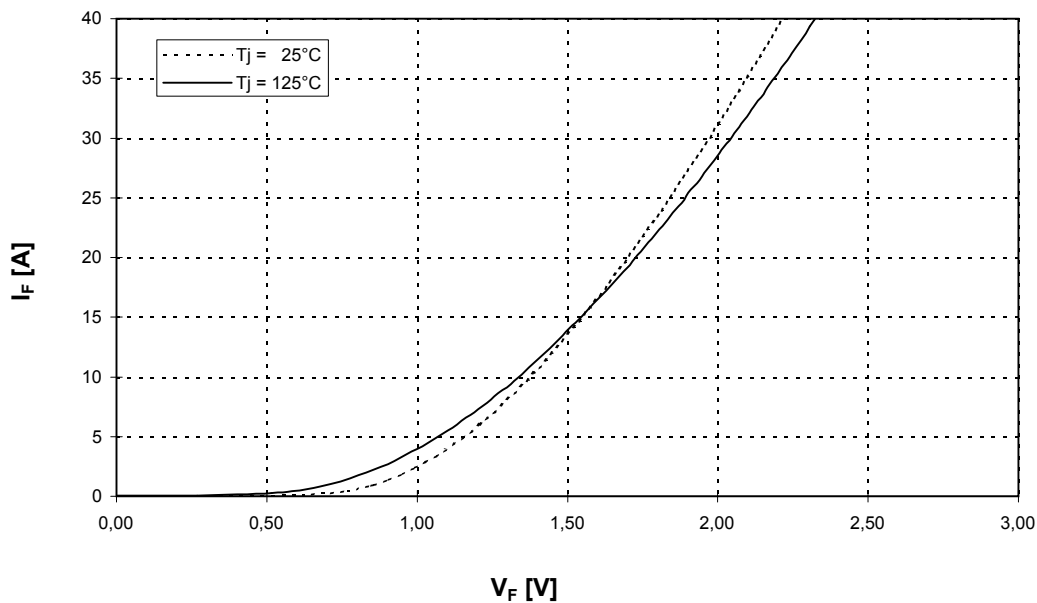
Vorläufig
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Übertragungscharakteristik Wechselr. (typisch)
Transfer characteristic Inverter (typical)

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



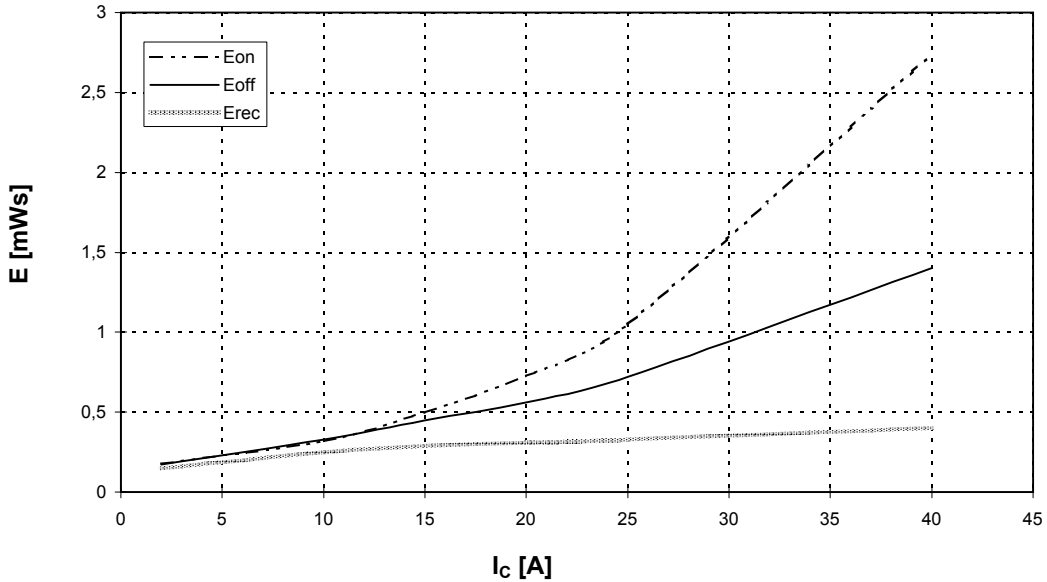
Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch) $I_F = f(V_F)$
Forward characteristic of FWD Inverter (typical)



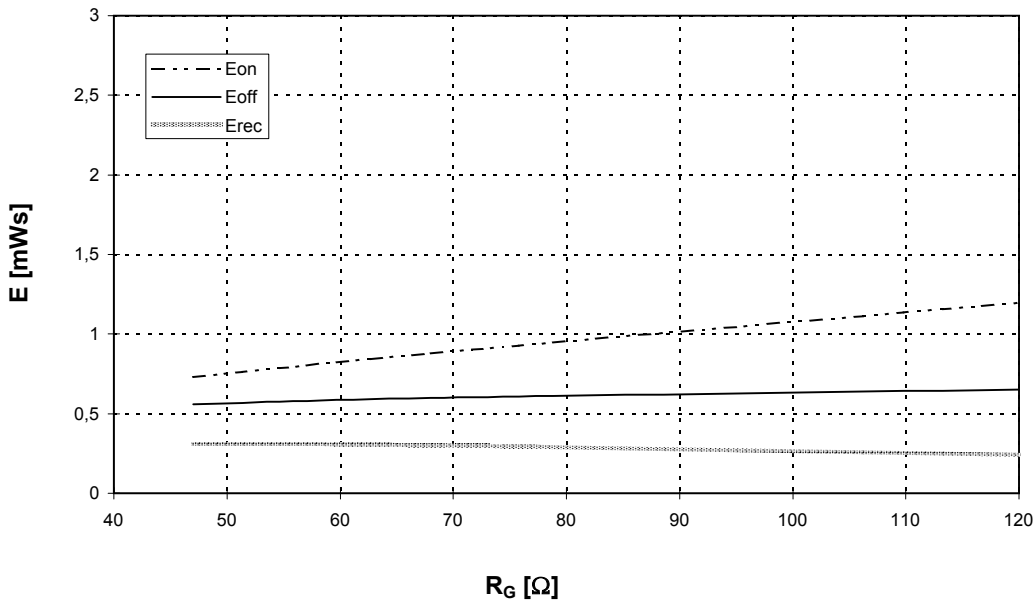


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Schaltverluste Wechselr. (typisch) $E_{on} = f(I_C), E_{off} = f(I_C), E_{rec} = f(I_C)$ $V_{CC} = 300\text{ V}$
 Switching losses Inverter (typical) $T_j = 125^\circ\text{C}, V_{GE} = \pm 15\text{ V}, R_{Gon} = R_{Goff} = 47\text{ Ohm}$



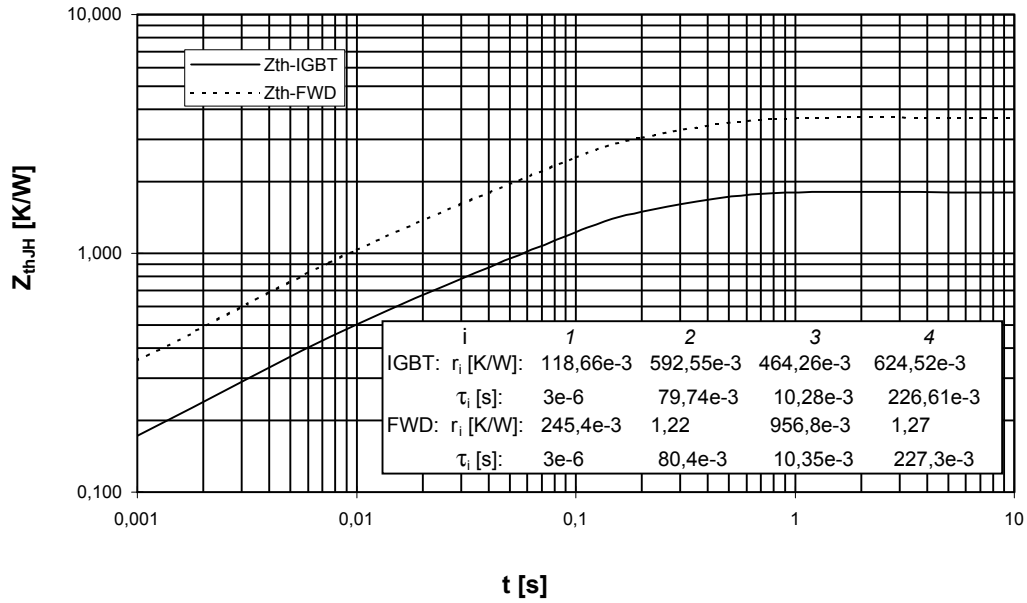
Schaltverluste Wechselr. (typisch) $E_{on} = f(R_G), E_{off} = f(R_G), E_{rec} = f(R_G)$
 Switching losses Inverter (typical) $T_j = 125^\circ\text{C}, V_{GE} = \pm 15\text{ V}, I_C = I_{nenn}, V_{CC} = 300\text{ V}$



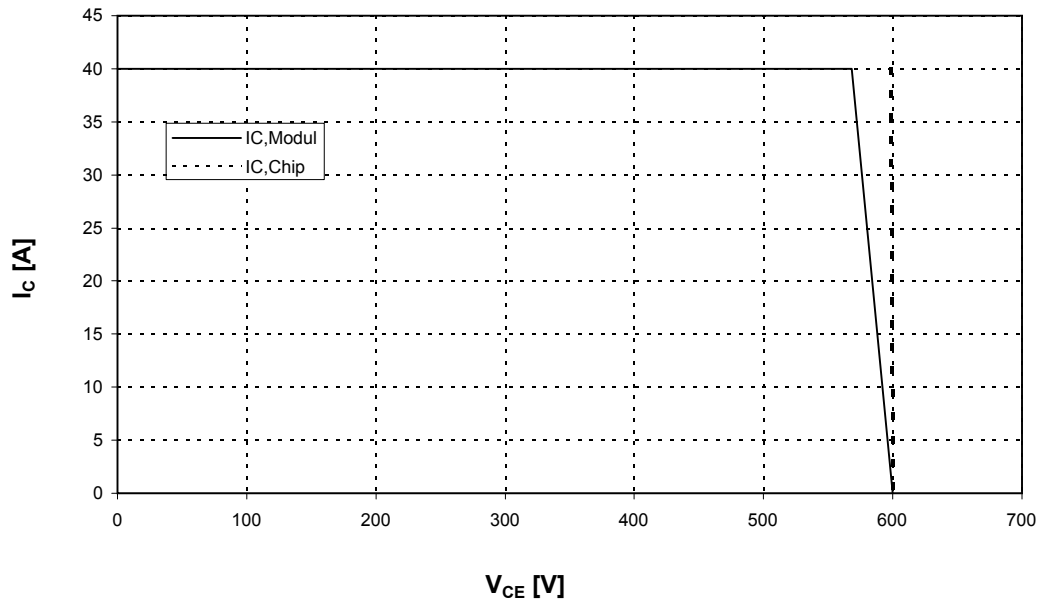


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Transienter Wärmewiderstand Wechsell. $Z_{thJH} = f(t)$
Transient thermal impedance Inverter



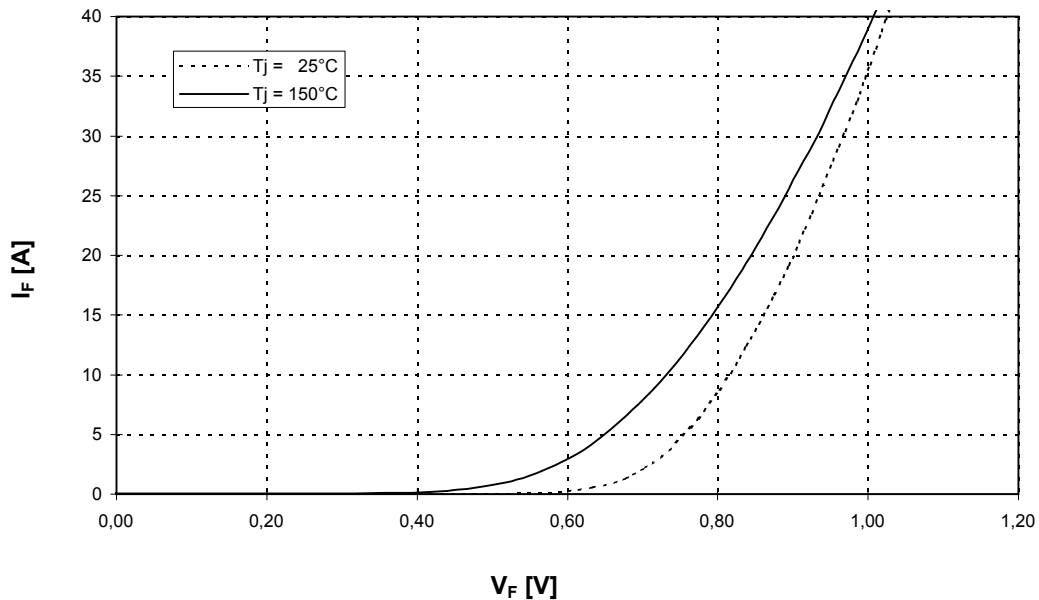
Sicherer Arbeitsbereich Wechsell. (RBSOA) $I_C = f(V_{CE})$
Reverse bias safe operating area Inverter (RBSOA) $T_{vj} = 125^\circ\text{C}$, $V_{GE} = \pm 15\text{V}$, $R_G = 47 \text{ Ohm}$



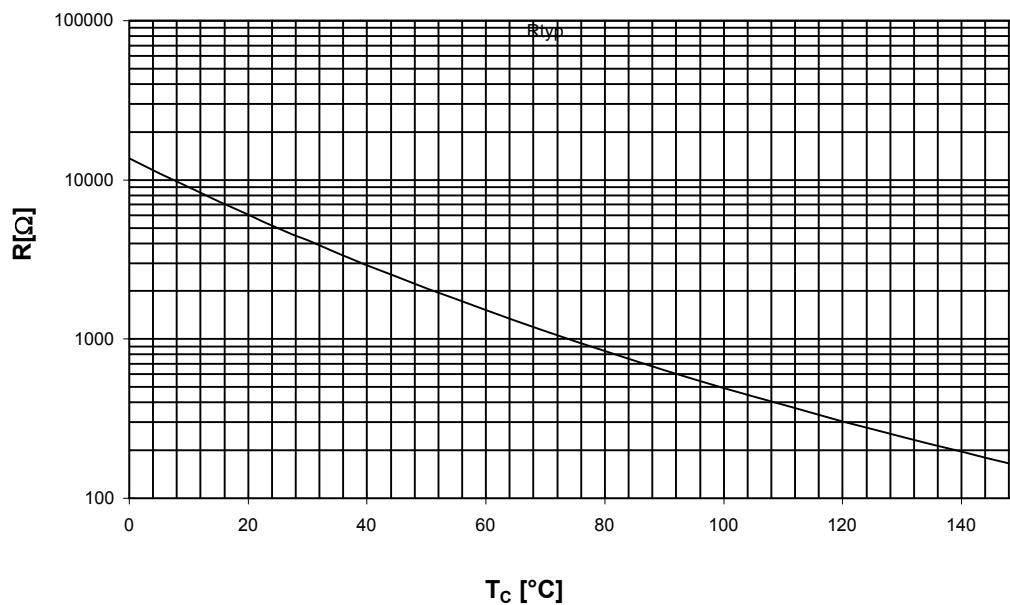


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Durchlaßkennlinie der Gleichrichterdiode (typisch) $I_F = f(V_F)$
Forward characteristic of Rectifier Diode (typical)



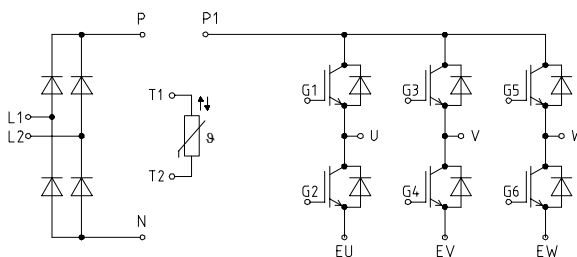
NTC- Temperaturkennlinie (typisch) $R = f(T)$
NTC- temperature characteristic (typical)





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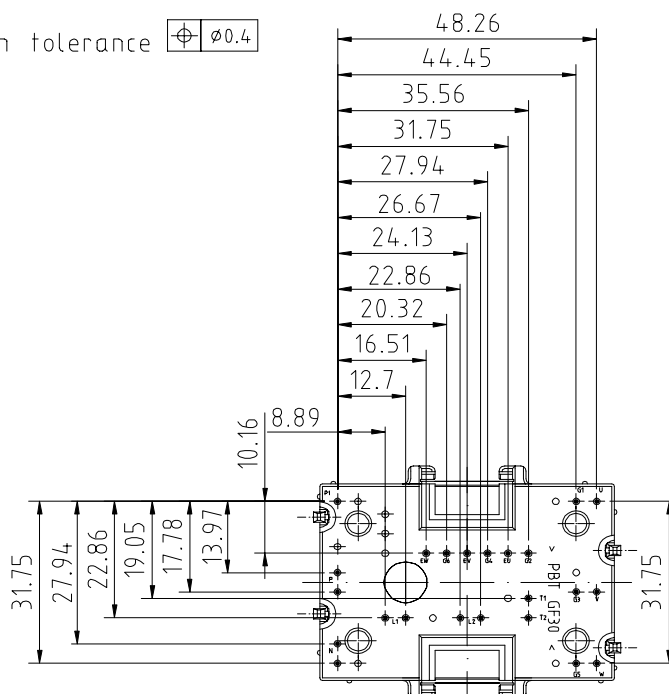
Schaltplan/ Circuit diagram



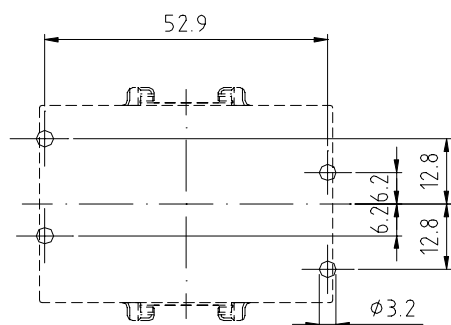
Gehäuseabmessungen/ Package outlines

Modul only designed for mounting on PCB's with 1.6 ±0.2 mm thickness

Pinpositions with tolerance $\varnothing 0.4$

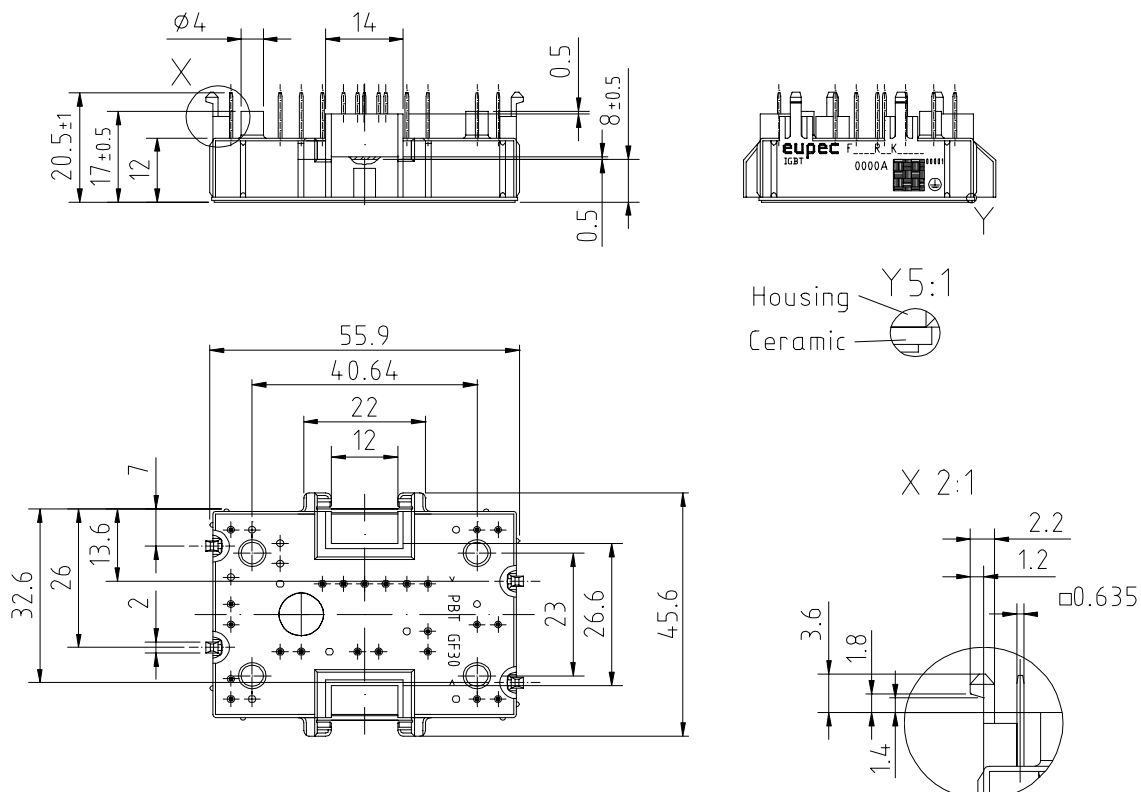


Bohrplan /
drilling layout





Gehäuseabmessungen Forts. / Package outlines contd.



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